

EXHIBIT B

Receipt is hereby acknowledged for the following in the U.S. Patent and Trademark Office:

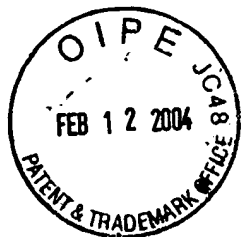
Applicant(s): PAVLIDIS et al.
Serial No.: 10/008,786
Confirmation No. 4745
Filed: November 13, 2001
Title: SYSTEM AND METHOD USING THERMAL IMAGE
ANALYSIS AND SLOPE THRESHOLD CLASSIFICATION
FOR POLYGRAPH TESTING

Enclosed: Submission of Drawings (1 pg.), eight sheets of drawings, and
transmittal document (in triplicate).

Mailed: 26 August 2003
Docket: H0002443-02 US (M&R 115.0025 0101)

MJG/ST





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FEB 20 2004

PATENT
Docket No. H0002443-02
(M&R 115.0025 0101)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):	PAVLIDIS et al.)	Group Art Unit:	2859
)		
Serial No.:	10/008,786)	Examiner:	G.K. VERBITSKY
Confirmation No.:	4745)		
)		
Filed:	November 13, 2001)		
)		
For:	SYSTEM AND METHOD USING THERMAL IMAGE ANALYSIS AND SLOPE THRESHOLD CLASSIFICATION FOR POLYGRAPH			

**CORRESPONDENCE TO EXAMINER RE: SUBMISSION
OF DRAWINGS UNDER 37 C.F.R. §1.85**

Attention: Examiner Verbitsky
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Examiner Verbitsky:

In response to Examiner's conversation on February 5, 2004 with our paralegal, Sandy Truehart, we are enclosing, per Examiner's request, copies of the Submission of Drawings and related documents (marked as Exhibit A), which we filed on August 26, 2003, and also a copy of the return receipt stamped postcard from the U.S. Patent and Trademark Office, which was stamped August 29, 2003 (marked as Exhibit B).

Examiner indicated that upon receipt of these documents, Examiner would proceed to withdraw the Notice of Abandonment mailed on December 19, 2003, for the above-identified patent application.

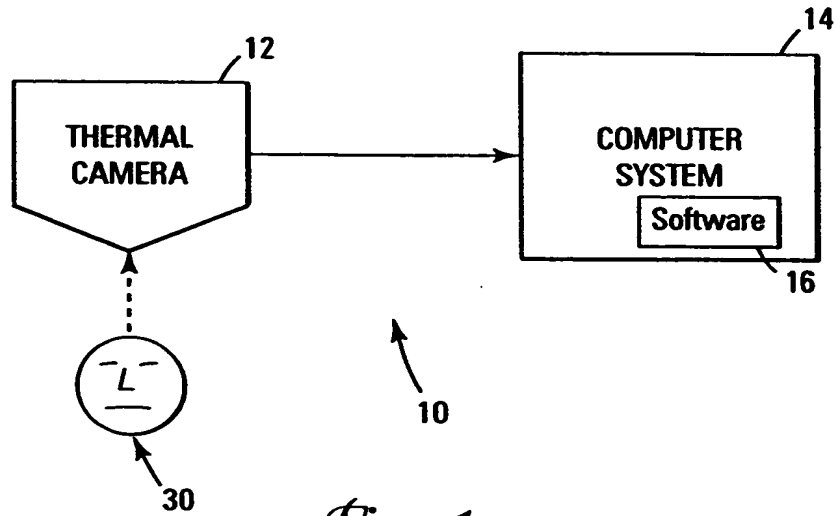


Fig. 1

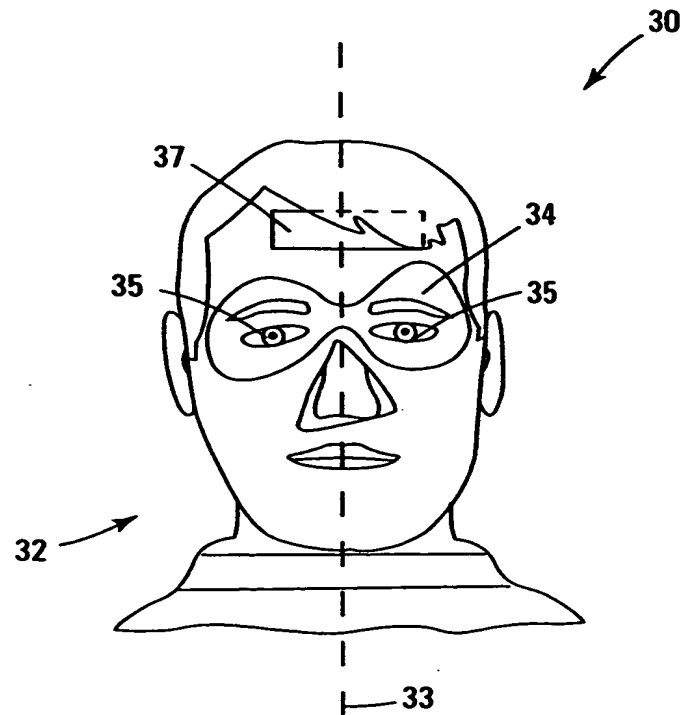


Fig. 3

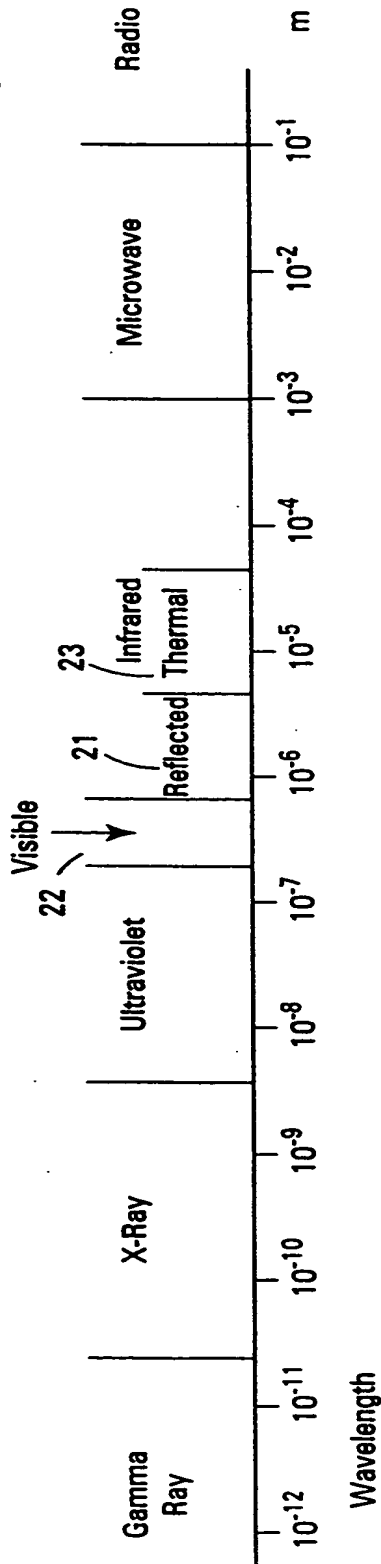


Fig. 2

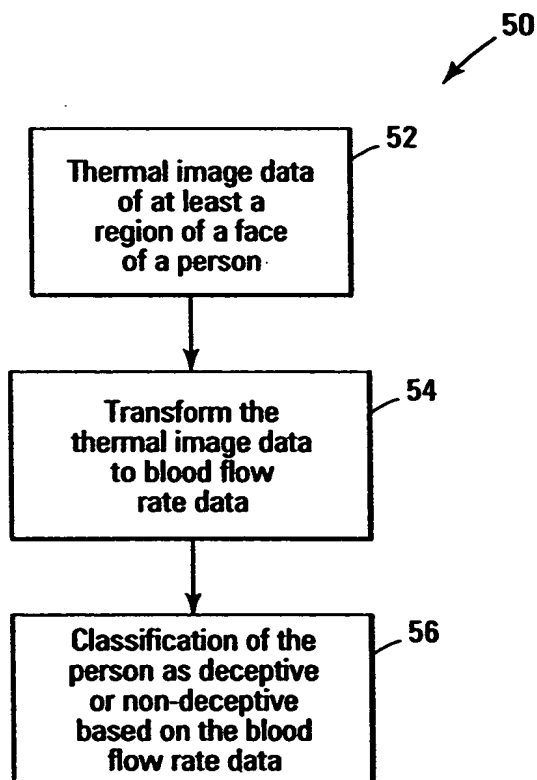


Fig. 4

Fig. 5A



Fig. 6A

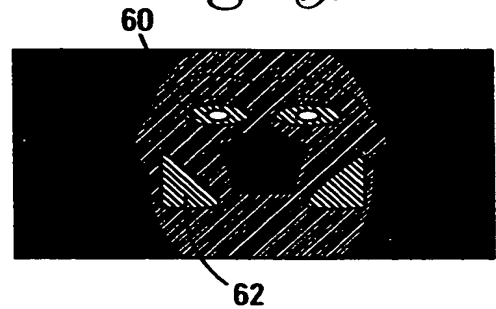
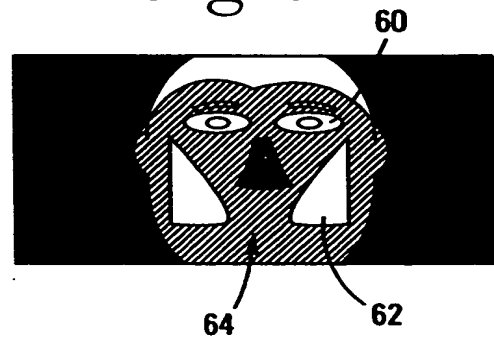
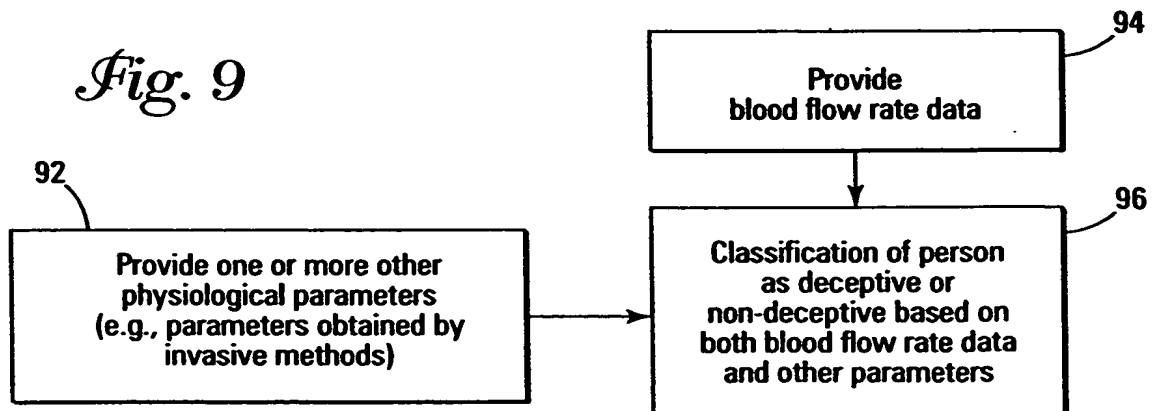
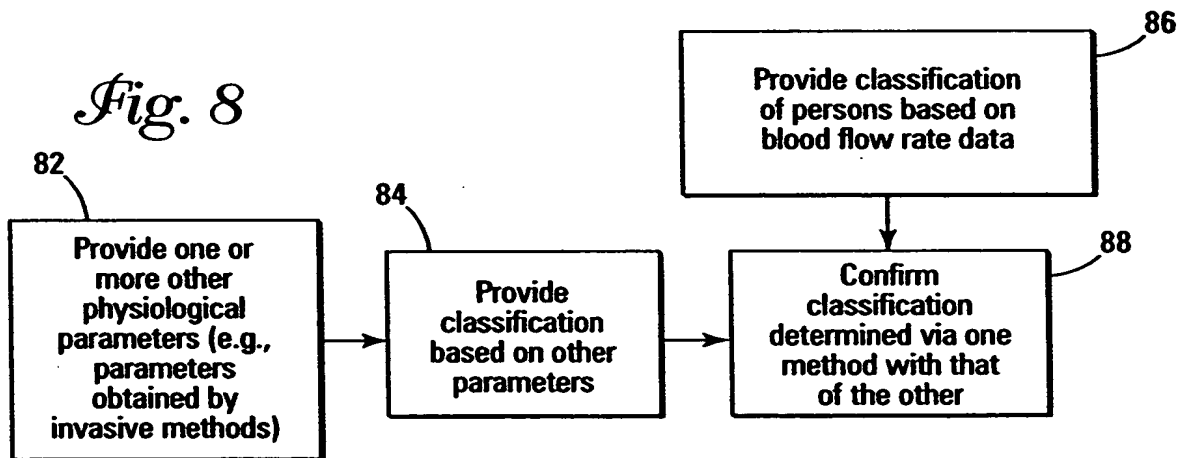
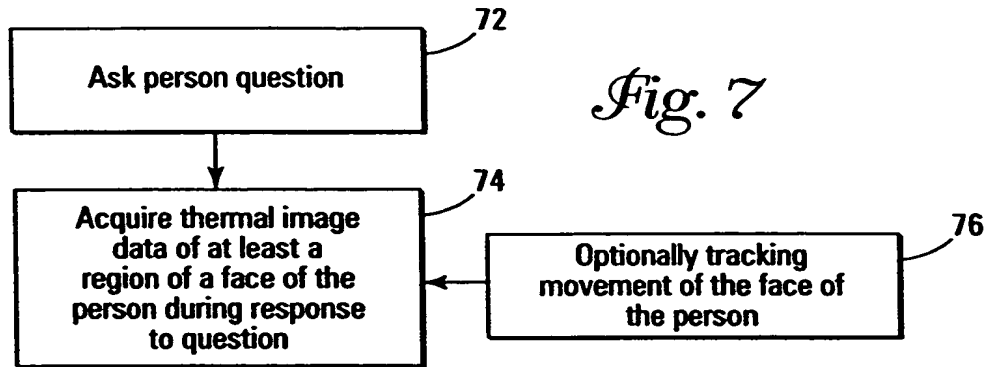


Fig. 5B



Fig. 6B





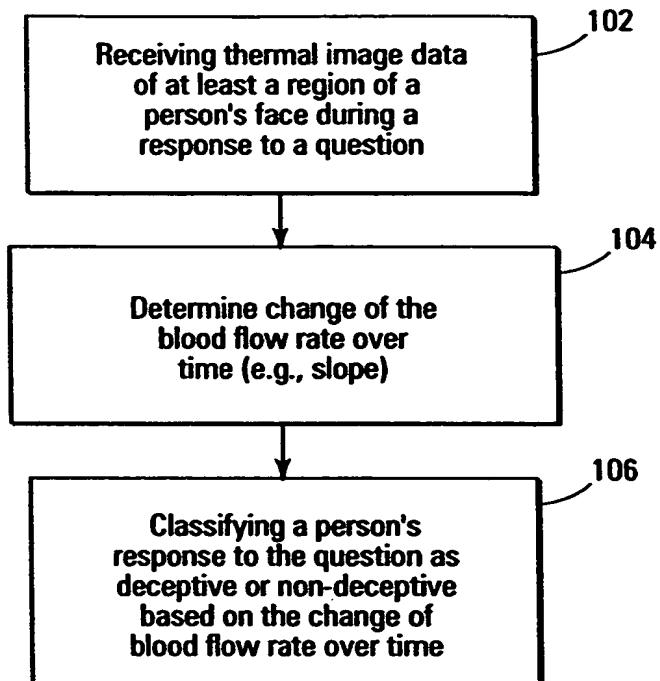


Fig. 10

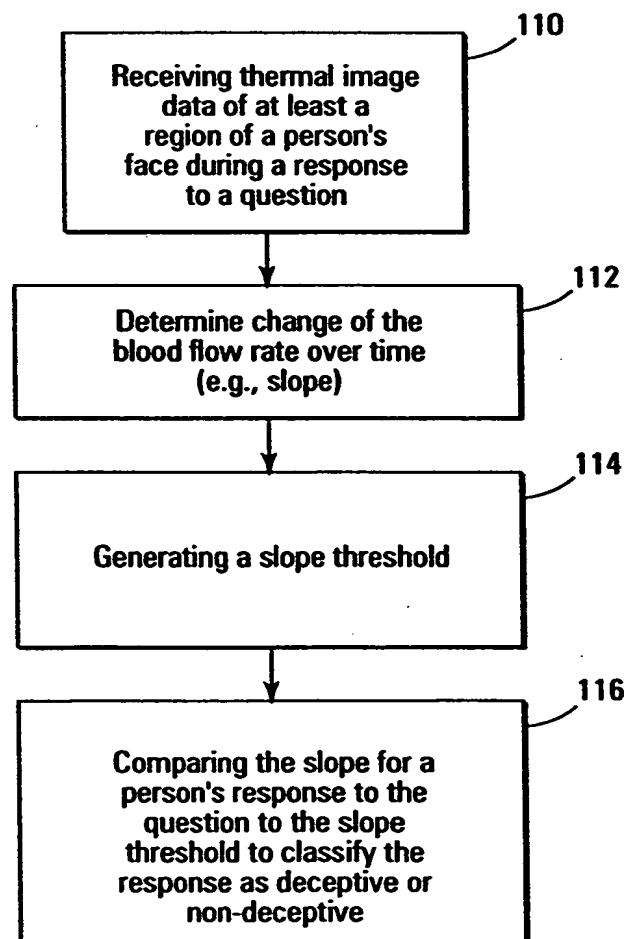


Fig. 11A

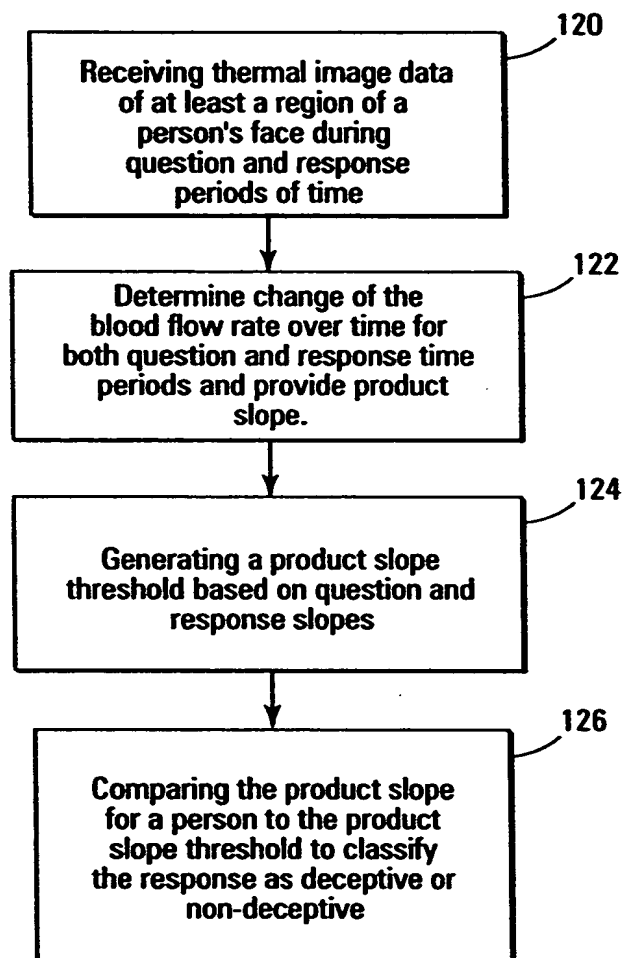


Fig. 11B

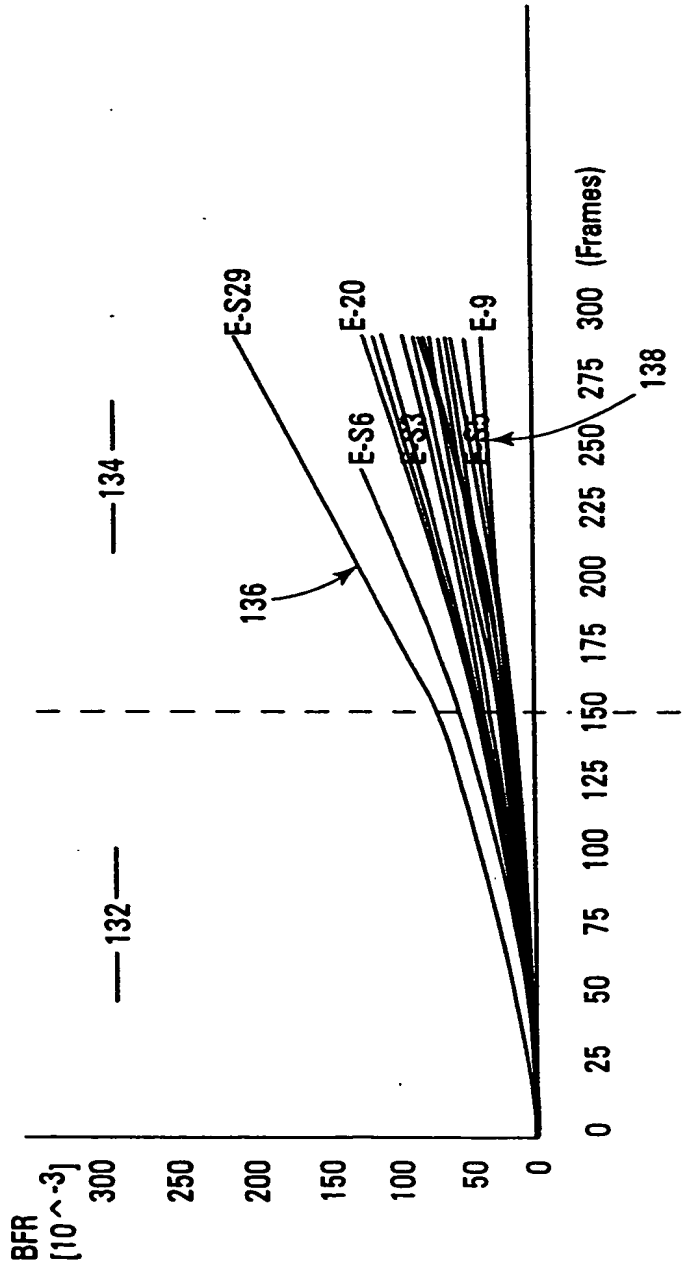


Fig. 12